

## Presettable Divide-By-N Counter

The MC14018B contains five Johnson counter stages which are asynchronously presettable and resettable. The counters are synchronous, and increment on the positive going edge of the clock.

Presetting is accomplished by a logic 1 on the preset enable input. Data on the Jam inputs will then be transferred to their respective  $\bar{Q}$  outputs (inverted). A logic 1 on the reset input will cause all  $\bar{Q}$  outputs to go to a logic 1 state.

Division by any number from 2 to 10 can be accomplished by connecting appropriate  $\bar{Q}$  outputs to the data input, as shown in the Function Selection table. Anti-lock gating is included in the MC14018B to assure proper counting sequence.

- Fully Static Operation
- Schmitt Trigger on Clock Input
- Capable of Driving Two Low-power TTL Loads or One Low-power Schottky TTL Load Over the Rated Temperature Range
- Pin-for-Pin Replacement for CD4018B

### MAXIMUM RATINGS\* (Voltages Referenced to $V_{SS}$ )

Symbol	Parameter	Value	Unit
$V_{DD}$	DC Supply Voltage	- 0.5 to + 18.0	V
$V_{in}, V_{out}$	Input or Output Voltage (DC or Transient)	- 0.5 to $V_{DD} + 0.5$	V
$I_{in}, I_{out}$	Input or Output Current (DC or Transient), per Pin	$\pm 10$	mA
$P_D$	Power Dissipation, per Package†	500	mW
$T_{stg}$	Storage Temperature	- 65 to + 150	°C
$T_L$	Lead Temperature (8-Second Soldering)	260	°C

\* Maximum Ratings are those values beyond which damage to the device may occur.

† Temperature Derating:

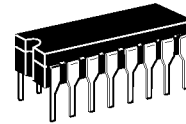
Plastic "P and D/DW" Packages: - 7.0 mW/°C From 65°C To 125°C

Ceramic "L" Packages: - 12 mW/°C From 100°C To 125°C

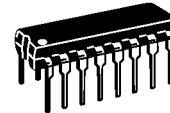
This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either  $V_{SS}$  or  $V_{DD}$ ). Unused outputs must be left open.

## MC14018B



**L SUFFIX**  
CERAMIC  
CASE 620



**P SUFFIX**  
PLASTIC  
CASE 648



**D SUFFIX**  
SOIC  
CASE 751B

### ORDERING INFORMATION

MC14XXXBCP Plastic  
MC14XXXBCL Ceramic  
MC14XXXBD SOIC

$T_A = -55^\circ \text{ to } 125^\circ \text{C}$  for all packages.

### FUNCTIONAL TRUTH TABLE

Clock	Reset	Preset Enable	Jam Input	$\bar{Q}_n$
	0	0	X	$\bar{Q}_n$
	0	0	X	$\bar{D}_n^*$
X	0	1	0	1
X	0	1	1	0
X	1	X	X	1

\*  $D_n$  is the Data input for that stage. Stage 1 has Data brought out to Pin 1.

### PIN ASSIGNMENT

$D_{in}$	1	16	$V_{DD}$
JAM 1	2	15	R
JAM 2	3	14	C
$\bar{Q}_2$	4	13	$\bar{Q}_5$
$\bar{Q}_1$	5	12	JAM 5
$\bar{Q}_3$	6	11	$\bar{Q}_4$
JAM 3	7	10	PE
$V_{SS}$	8	9	JAM 4



**ELECTRICAL CHARACTERISTICS** (Voltages Referenced to  $V_{SS}$ )

Characteristic	Symbol	$V_{DD}$ Vdc	-55°C		25°C			125°C		Unit
			Min	Max	Min	Typ #	Max	Min	Max	
Output Voltage "0" Level $V_{in} = V_{DD}$ or 0	$V_{OL}$	5.0	—	0.05	—	0	0.05	—	0.05	Vdc
		10	—	0.05	—	0	0.05	—	0.05	
$V_{in} = 0$ or $V_{DD}$ "1" Level	$V_{OH}$	5.0	4.95	—	4.95	5.0	—	4.95	—	Vdc
		10	9.95	—	9.95	10	—	9.95	—	
Input Voltage "0" Level ( $V_O = 4.5$ or $0.5$ Vdc) ( $V_O = 9.0$ or $1.0$ Vdc) ( $V_O = 13.5$ or $1.5$ Vdc)	$V_{IL}$	5.0	—	1.5	—	2.25	1.5	—	1.5	Vdc
		10	—	3.0	—	4.50	3.0	—	3.0	
		15	—	4.0	—	6.75	4.0	—	4.0	
( $V_O = 0.5$ or $4.5$ Vdc) ( $V_O = 1.0$ or $9.0$ Vdc) ( $V_O = 1.5$ or $13.5$ Vdc) "1" Level	$V_{IH}$	5.0	3.5	—	3.5	2.75	—	3.5	—	Vdc
		10	7.0	—	7.0	5.50	—	7.0	—	
		15	11	—	11	8.25	—	11	—	
Output Drive Current ( $V_{OH} = 2.5$ Vdc) ( $V_{OH} = 4.6$ Vdc) ( $V_{OH} = 9.5$ Vdc) ( $V_{OH} = 13.5$ Vdc) Source	$I_{OH}$	5.0	-3.0	—	-2.4	-4.2	—	-1.7	—	mAdc
		5.0	-0.64	—	-0.51	-0.88	—	-0.36	—	
		10	-1.6	—	-1.3	-2.25	—	-0.9	—	
		15	-4.2	—	-3.4	-8.8	—	-2.4	—	
( $V_{OL} = 0.4$ Vdc) ( $V_{OL} = 0.5$ Vdc) ( $V_{OL} = 1.5$ Vdc) Sink	$I_{OL}$	5.0	0.64	—	0.51	0.88	—	0.36	—	mAdc
		10	1.6	—	1.3	2.25	—	0.9	—	
		15	4.2	—	3.4	8.8	—	2.4	—	
Input Current	$I_{in}$	15	—	$\pm 0.1$	—	$\pm 0.00001$	$\pm 0.1$	—	$\pm 1.0$	$\mu$ Adc
Input Capacitance ( $V_{in} = 0$ )	$C_{in}$	—	—	—	—	5.0	7.5	—	—	pF
Quiescent Current (Per Package)	$I_{DD}$	5.0	—	5.0	—	0.005	5.0	—	150	$\mu$ Adc
		10	—	10	—	0.010	10	—	300	
		15	—	20	—	0.015	20	—	600	
Total Supply Current**† (Dynamic plus Quiescent, Per Package) ( $C_L = 50$ pF on all outputs, all buffers switching)	$I_T$	5.0	$I_T = (0.3 \mu\text{A/kHz}) f + I_{DD}$							$\mu$ Adc
		10	$I_T = (0.7 \mu\text{A/kHz}) f + I_{DD}$							
		15	$I_T = (1.0 \mu\text{A/kHz}) f + I_{DD}$							

#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

\*\*The formulas given are for the typical characteristics only at 25°C.

†To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) Vfk$$

where:  $I_T$  is in  $\mu\text{A}$  (per package),  $C_L$  in pF,  $V = (V_{DD} - V_{SS})$  in volts,  $f$  in kHz is input frequency, and  $k = 0.001$ .

**SWITCHING CHARACTERISTICS\*** ( $C_L = 50 \text{ pF}$ ,  $T_A = 25^\circ\text{C}$ )

Characteristic	Symbol	$V_{DD}$ Vdc	All Types			Unit
			Min	Typ #	Max	
Output Rise and Fall Time $t_{TLH}$ , $t_{THL} = (1.35 \text{ ns/pF}) C_L + 32 \text{ ns}$ $t_{TLH}$ , $t_{THL} = (0.6 \text{ ns/pF}) C_L + 20 \text{ ns}$ $t_{TLH}$ , $t_{THL} = (0.4 \text{ ns/pF}) C_L + 20 \text{ ns}$	$t_{TLH}$ , $t_{THL}$	5.0 10 15	— — —	100 50 40	200 100 80	ns
Propagation Delay Time Clock to $\bar{Q}$ $t_{PLH}$ , $t_{PHL} = (0.90 \text{ ns/pF}) C_L + 265 \text{ ns}$ $t_{PLH}$ , $t_{PHL} = (0.36 \text{ ns/pF}) C_L + 102 \text{ ns}$ $t_{PLH}$ , $t_{PHL} = (0.26 \text{ ns/pF}) C_L + 72 \text{ ns}$	$t_{PLH}$ , $t_{PHL}$	5.0 10 15	— — —	310 120 85	620 240 170	ns
Reset to $\bar{Q}$ $t_{PLH} = (0.90 \text{ ns/pF}) C_L + 325 \text{ ns}$ $t_{PLH} = (0.36 \text{ ns/pF}) C_L + 132 \text{ ns}$ $t_{PLH} = (0.26 \text{ ns/pF}) C_L + 81 \text{ ns}$		5.0 10 15	— — —	370 150 100	740 300 200	ns
Preset Enable to $\bar{Q}$ $t_{PLH}$ , $t_{PHL} = (0.90 \text{ ns/pF}) C_L + 325 \text{ ns}$ $t_{PLH}$ , $t_{PHL} = (0.36 \text{ ns/pF}) C_L + 132 \text{ ns}$ $t_{PLH}$ , $t_{PHL} = (0.26 \text{ ns/pF}) C_L + 81 \text{ ns}$		5.0 10 15	— — —	370 150 100	740 300 200	ns
Setup Time Data (Pin 1) to Clock	$t_{su}$	5.0 10 15	200 100 80	0 0 0	— — —	ns
Jam Inputs to Preset Enable		5.0 10 15	200 100 80	0 0 0	— — —	ns
Data (Jam Inputs)—to—Preset Enable Hold Time	$t_h$	5.0 10 15	540 500 480	270 250 240	— — —	ns
Clock Pulse Width	$t_{WH}$	5.0 10 15	400 200 160	200 100 80	— — —	ns
Reset or Preset Enable Pulse Width	$t_{WH}$	5.0 10 15	290 130 110	145 65 55	— — —	ns
Clock Rise and Fall Time	$t_{TLH}$ , $t_{THL}$	5.0 10 15	No Limit			ns
Clock Pulse Frequency	$f_{cl}$	5.0 10 15	— — —	2.5 6.5 8.0	1.25 3.25 4.0	MHz

\* The formulas given are for the typical characteristics only at 25°C.

#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

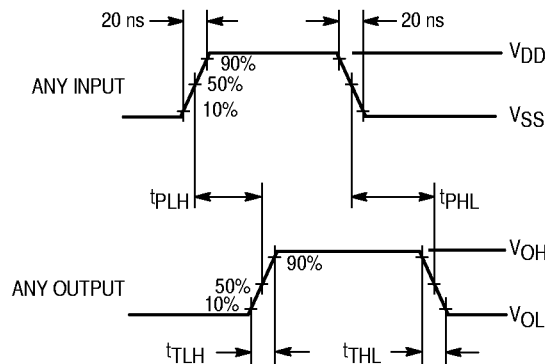
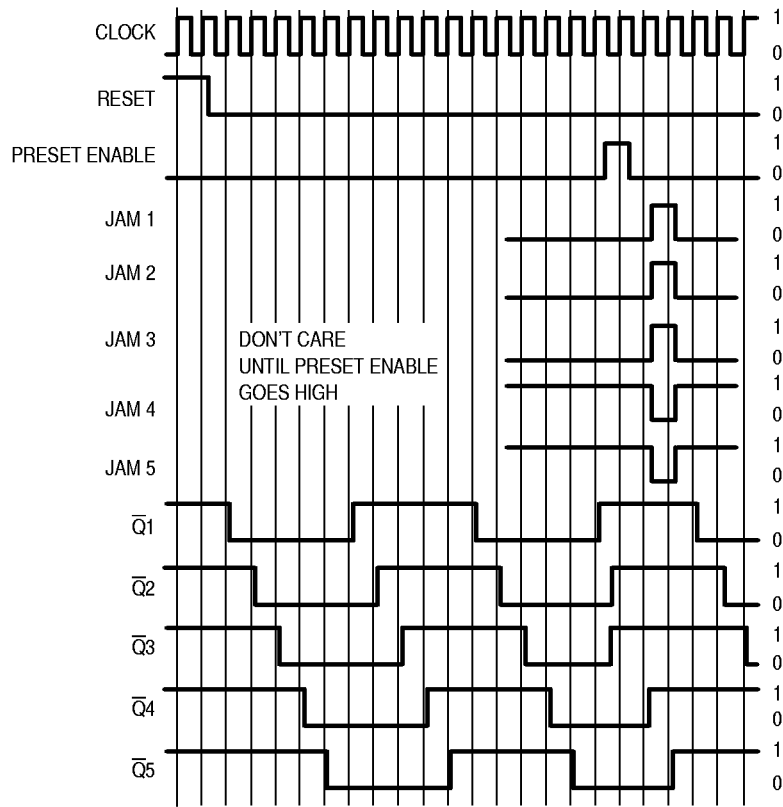


Figure 1. Switching Time Waveforms

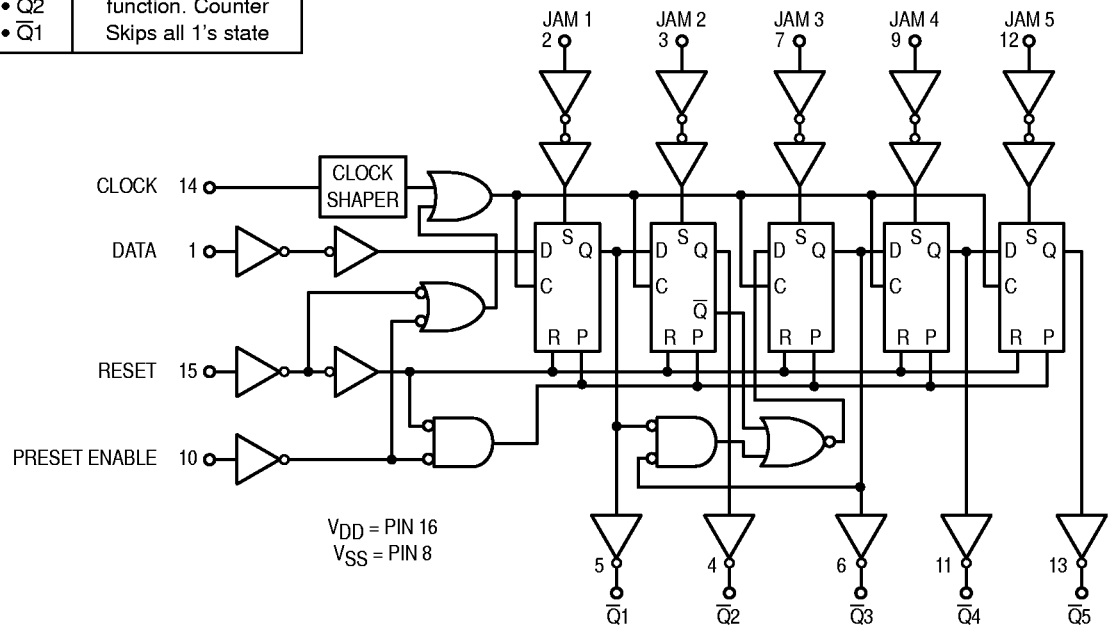
**TIMING DIAGRAM**  
( $\overline{Q5}$  Connected to Data Input)



**FUNCTION SELECTION**

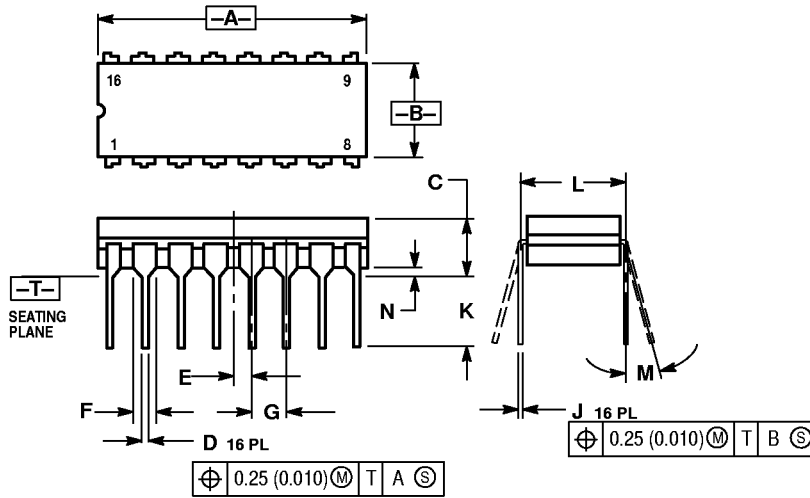
Counter Mode	Connect Data Input (Pin 1) to:	Comments
Divide by 10 Divide by 8 Divide by 6 Divide by 4 Divide by 2	$\overline{Q5}$ $\overline{Q4}$ $\overline{Q3}$ $\overline{Q2}$ $\overline{Q1}$	No external components needed.
Divide by 9 Divide by 7 Divide by 5 Divide by 3	$\overline{Q5} \cdot \overline{Q4}$ $\overline{Q4} \cdot \overline{Q3}$ $\overline{Q3} \cdot \overline{Q2}$ $\overline{Q2} \cdot \overline{Q1}$	Gate package needed to provide AND function. Counter Skips all 1's state

**LOGIC DIAGRAM**



## OUTLINE DIMENSIONS

### L SUFFIX CERAMIC DIP PACKAGE CASE 620-10 ISSUE V

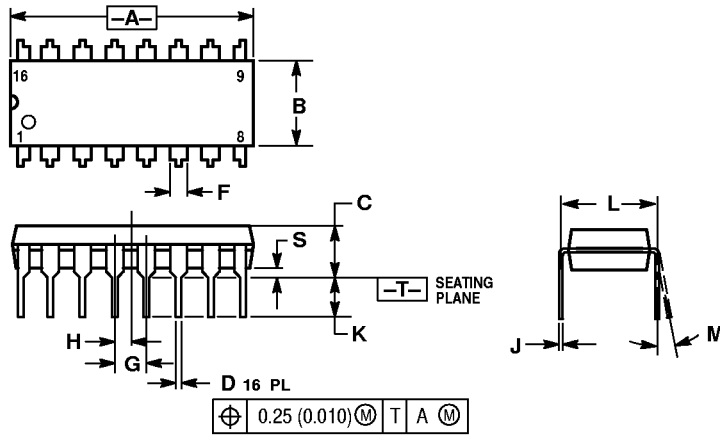


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	—	0.200	—	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0° 15°		0° 15°	
N	0.020	0.040	0.51	1.01

### P SUFFIX PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



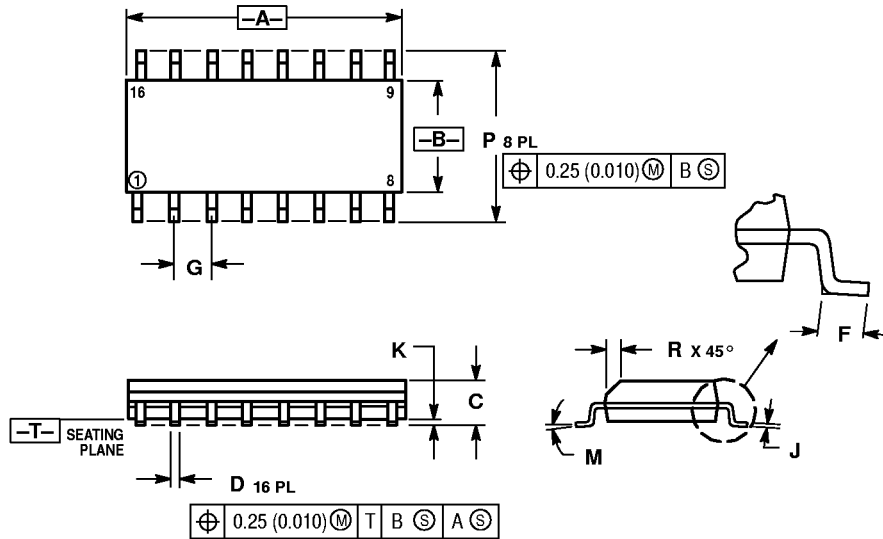
**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0° 10°		0° 10°	
S	0.020	0.040	0.51	1.01

## OUTLINE DIMENSIONS

### D SUFFIX PLASTIC SOIC PACKAGE CASE 751B-05 ISSUE J



**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

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MC14018B/D

